



**ST7407** Pb  
Lead-free  
P Channel Enhancement Mode MOSFET

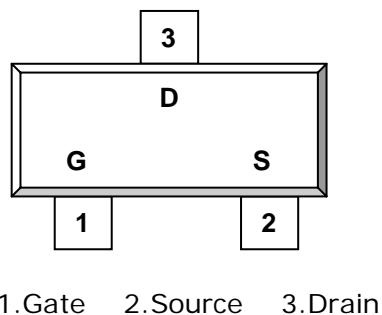
-3.4A

## DESCRIPTION

The ST7407 is the P-Channel logic enhancement mode power field effect transistors. It is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone, notebook computer power management and other battery powered circuits where high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

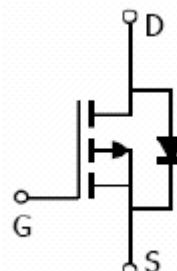
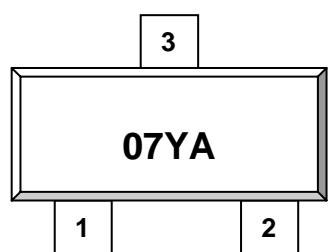
## PIN CONFIGURATION SOT-323 (SC-70)



## FEATURE

- -20V/-3.4A,  $R_{DS(ON)} = 100\text{m-ohm}$  @VGS = -4.5V
- -20V/-2.4A,  $R_{DS(ON)} = 125\text{m-ohm}$  @VGS = -2.5V
- -20V/-1.8A,  $R_{DS(ON)} = 170\text{m-ohm}$  @VGS = -1.8V
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-323 (SC-70) package design

## PART MARKING SOT-323 (SC-70)



Y: Year Code    A: Process Code

## ORDERING INFORMATION

Part Number	Package	Part Marking
ST7407S32RG	SOT-323	07YA

\* Process Code : A ~ Z ; a ~ z

\* ST7407S32RG    S32 : SOT-323 ; R : Tape Reel ; G : Pb – Free



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**ABSOULTE MAXIMUM RATINGS** (Ta = 25°C Unless otherwise noted )

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-20	V
Gate-Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current TJ=150°C	I <sub>D</sub>	-2.3 -1.7	A
Pulsed Drain Current	I <sub>DM</sub>	-6	A
Continuous Source Current (Diode Conduction)	I <sub>S</sub>	-1.4	A
Power Dissipation	P <sub>D</sub>	0.35 0.22	W
Operation Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	120	°C/W

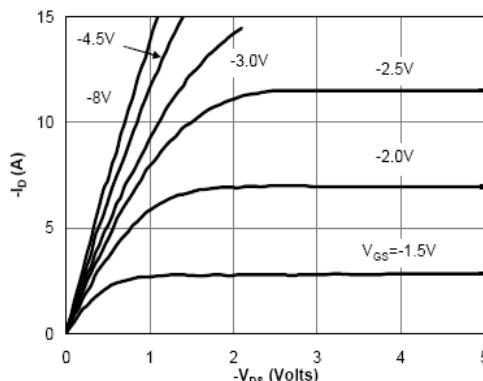
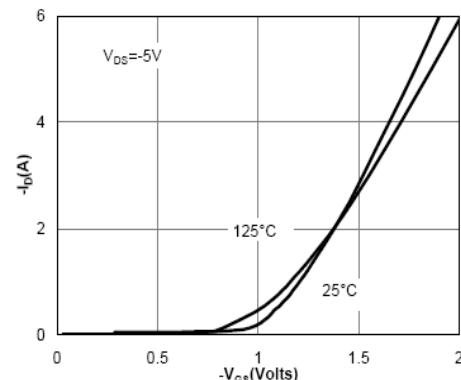
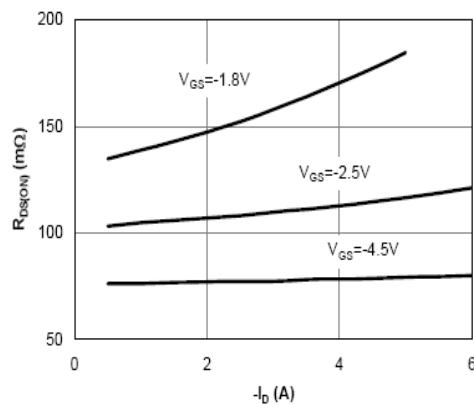
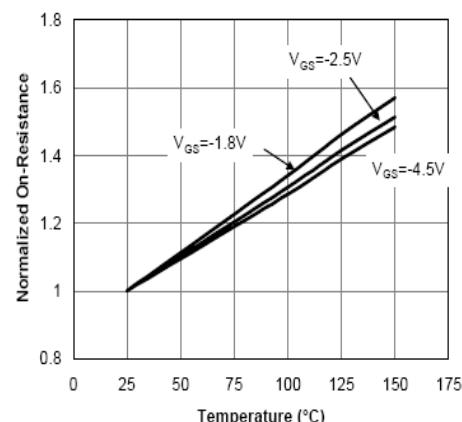
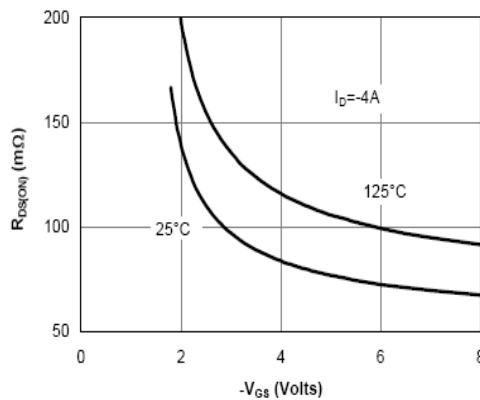
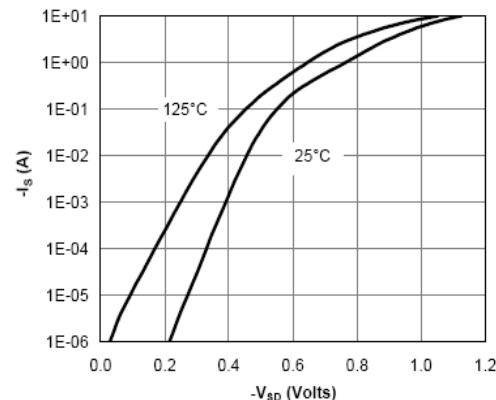


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**ELECTRICAL CHARACTERISTICS ( Ta = 25°C Unless otherwise noted )**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	-20			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	-0.35		-0.8	V
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V			-1	uA
		V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C			-5.0	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> ≤-5V, V <sub>GS</sub> =-4.5V V <sub>DS</sub> ≤-5V, V <sub>GS</sub> =-2.5V	-6 -3			A
Drain-source On-Resistance	R <sub>DSS(on)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3.4A V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2.4A V <sub>GS</sub> =-1.8V, I <sub>D</sub> =-1.8A		0.090 0.115 0.150	0.100 0.125 0.170	Ω
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-2.8V		6.0		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1.6A, V <sub>GS</sub> =0V		-0.8	-1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-6V V <sub>GS</sub> =-4.5V I <sub>D</sub> =-2.8A		4.8	8.0	nC
Gate-Source Charge	Q <sub>gs</sub>			1.0		
Gate-Drain Charge	Q <sub>gd</sub>			1.0		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-6.0V V <sub>GS</sub> =0V F=1MHz		485		pF
Output Capacitance	C <sub>oss</sub>			85		
Reverse Transfer Capacitance	C <sub>rss</sub>			40		
Turn-On Time	t <sub>d(on)</sub> tr	V <sub>DD</sub> =-6V R <sub>L</sub> =6Ω I <sub>D</sub> =-1.0A V <sub>GEN</sub> =-4.5V R <sub>G</sub> =6Ω		10	16	nS
Turn-Off Time	t <sub>d(off)</sub> tf			13	23	
				18	25	
				15	20	

**-3.4A**
**TYPICAL CHARACTERISTICS (25°C Unless noted)**

**Fig 1: On-Region Characteristics**

**Figure 2: Transfer Characteristics**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage**

**Figure 4: On-Resistance vs. Junction Temperature**

**Figure 5: On-Resistance vs. Gate-Source Voltage**

**Figure 6: Body-Diode Characteristics**



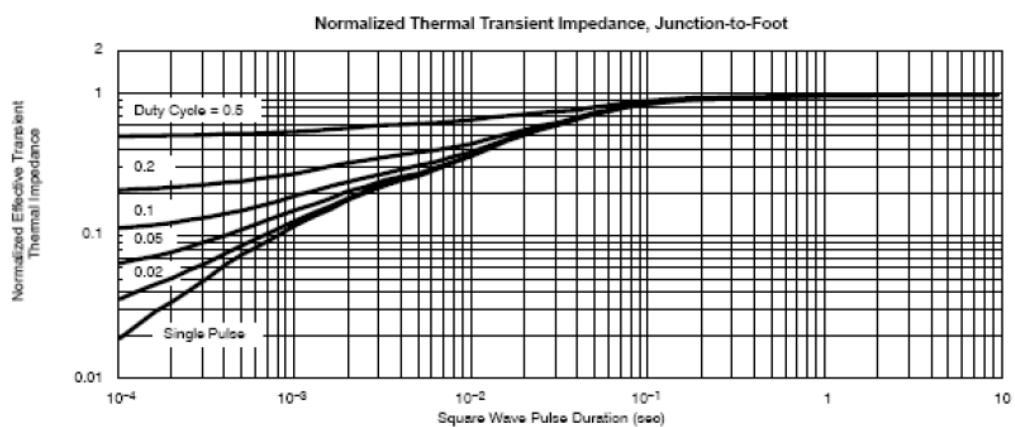
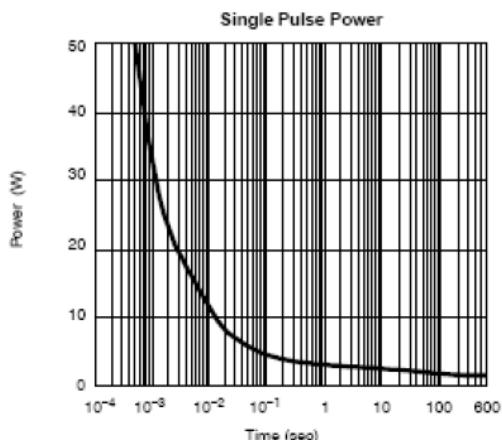
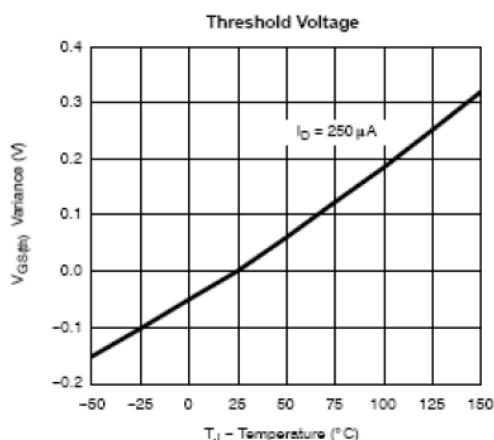
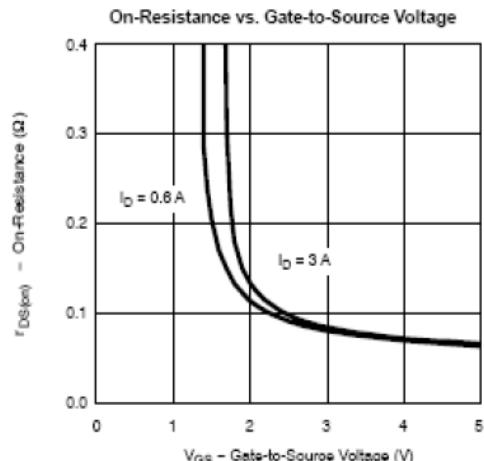
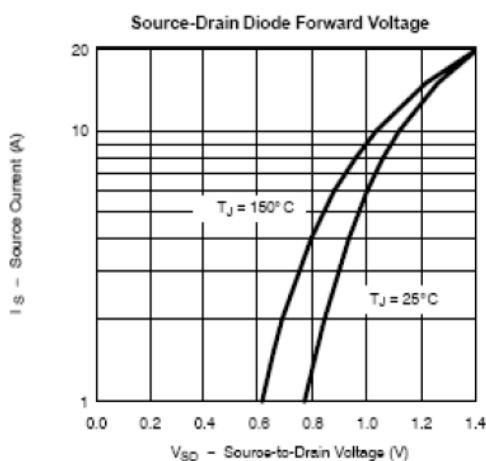
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**SOT-323 (SC-70) PACKAGE OUTLINE**

